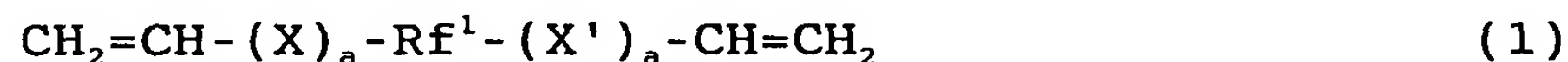
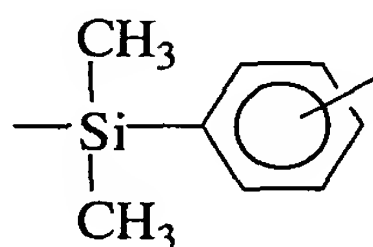


CLAIMS:

1. A curable composition comprising
 - (A) 100 parts by weight of an alkenyl-containing fluoropolymer comprising $-(CF(CF_3)-CF_2-O)-$ units,
 - (B) 20 to 40 parts by weight of an alkenyl-free, non-functional fluoropolymer comprising $-[(CF_2)_kO]-$ units wherein k is 1 to 6,
 - (C) a cure effective amount of an organohydrogensiloxane having at least two hydrogen atoms each attached to a silicon atom in a molecule, and
 - (D) a catalytic amount of a platinum group metal catalyst.
2. The curable composition of claim 1 wherein component (A) comprises a branched polyfluorodialkenyl compound of the following general formula (1):

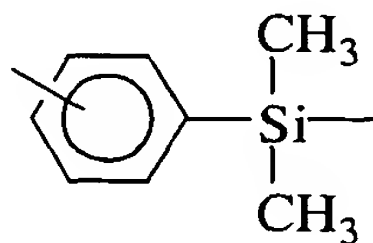


wherein X is a divalent group represented by $-CH_2-$, $-CH_2O-$, $-CH_2OCH_2-$ or $-Y-NR^1-CO-$ wherein Y is a divalent group represented by $-CH_2-$ or



- and R^1 is hydrogen or a substituted or unsubstituted monovalent hydrocarbon group,

X' is a divalent group represented by $-CH_2-$, $-OCH_2-$, $-CH_2OCH_2-$ or $-CO-NR^1-Y'-$ wherein Y' is a divalent group represented by $-CH_2-$ or

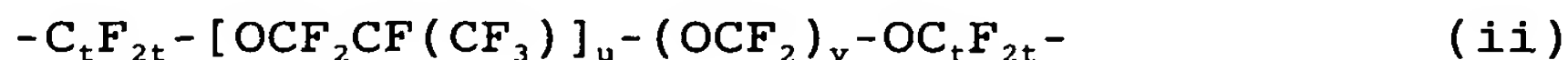


and R^1 is as defined above, "a" is independently equal to 0 or 1,

Rf¹ is a divalent group having the general formula (i):



5 wherein p and q each are an integer of 1 to 150, the sum of p and q on average is 2 to 200, r is an integer of 0 to 6, and t is 2 or 3, or the general formula (ii):



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wherein u is an integer of 1 to 200, v is an integer of 1 to 50, and t is as defined above.

3. The curable composition of claim 2 wherein component
15 (A) further comprises a branched polyfluoromonoalkenyl compound of the following general formula (2):



20 wherein X' and "a" are as defined above, Rf² is a group of the general formula (iii):



25 wherein t is as defined above, and w is an integer of 1 to 150, which is smaller than any of the sum of p+q (average) and r and the sum of u and v for Rf¹ in formula (1).

4. The curable composition of claim 2 wherein component
30 (B) is at least one linear polyfluoro compound selected from the group consisting of compounds having the general formula (3):



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wherein A is a group of the formula: C_sF_{2s+1}- wherein s is 1 to 3, and c is an integer of 1 to 200, which is smaller than any of the sum of p+q (average) and r and the sum of u and v for Rf¹ in formula (1), and compounds having the general formula
40 (4):



wherein A is as defined above, d and e each are an integer of 1 to 200, and the sum of d and e is equal to or smaller than any of the sum of p+q (average) and r and the sum of u and v for Rf^1 in formula (1).

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5. An electric or electronic part encapsulated with the curable composition of any one of claim 1.